

## PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1  
Stylesheet Version v1.2

EPAS ID: PAT5877468

<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	RELEASE OF SECURITY INTEREST
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
MUFG UNION BANK, N.A.	12/06/2019
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	Cypress Semiconductor Corporation
<b>Street Address:</b>	198 Champion Court
<b>City:</b>	San Jose
<b>State/Country:</b>	CALIFORNIA
<b>Postal Code:</b>	95134
<b>PROPERTY NUMBERS Total: 18</b>	
<b>Property Type</b>	<b>Number</b>
Application Number:	09855868
Application Number:	09973743
Application Number:	10649994
Application Number:	09795849
Application Number:	60265426
Application Number:	10050483
Application Number:	10050257
Application Number:	10136033
Application Number:	10357879
Application Number:	10259761
Application Number:	11444216
Application Number:	13081777
Application Number:	11034642
Application Number:	11493468
Application Number:	13026075
Application Number:	11229530
Application Number:	12195324
Application Number:	13156122
<b>CORRESPONDENCE DATA</b>	

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**Correspondent Name:** CYPRESS SEMICONDUCTOR CORPORATION

**Address Line 1:** 198 CHAMPION COURT

**Address Line 4:** SAN JOSE, CALIFORNIA 95134

<b>ATTORNEY DOCKET NUMBER:</b>	LFMS SECURITY RELEASE
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<b>NAME OF SUBMITTER:</b>	CHRISTOPHER JORDAN
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<b>SIGNATURE:</b>	/Christopher Jordan/
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<b>DATE SIGNED:</b>	12/19/2019
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**Total Attachments: 4**

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## PARTIAL RELEASE OF SECURITY INTEREST IN PATENTS

December 6, 2019

This PARTIAL RELEASE OF SECURITY INTEREST IN PATENTS (this “**Release**”) is made and executed by MUFG Union Bank, N.A., as collateral agent for the Secured Parties (as defined in the Pledge and Security Agreement referred to below) (the “**Collateral Agent**”), in favor of Cypress Semiconductor Corporation, a Delaware corporation (“**Cypress**”), and Spansion LLC, a Delaware limited liability company (each a “**Grantor**” and collectively, the “**Grantors**”). Capitalized terms used but not defined herein shall have the meanings ascribed to such terms in the Pledge and Security Agreement.

A. Pursuant to that certain Amended and Restated Pledge and Security Agreement, dated March 12, 2015 (as further amended and/or restated, supplemented or otherwise modified from time to time, the “**Pledge and Security Agreement**”), as security for the prompt and complete payment and performance in full when due (whether at stated maturity, by required prepayment, declaration, acceleration, demand or otherwise, including the payment of amounts that would become due but for the operation of the automatic stay under Section 362(a) of the Bankruptcy Code) of all Secured Obligations, each Grantor pledged and granted to Morgan Stanley Senior Funding, Inc. as the former collateral agent (“**MSSF**”), for its benefit and for the benefit of the Secured Parties, a continuing security interest in and Lien of all of its right, title, and interest in, to and under the Collateral.

B. The Collateral Agent entered into certain Assignment and Assumption of Security Interest in Intellectual Property Agreements, effective as of July 31, 2019, with MSSF, whereby MSSF assigned to the Collateral Agent its right, title and interest in and to the Patent Security Agreements (as defined therein), and in connection therewith, the security interest in and Lien on all of MSSF’s right, title and interest in, to and under all Patent Collateral (as defined in the Patent Security Agreements).

C. Cypress, on behalf of itself and the other Grantors, hereby requests that the Collateral Agent release its continuing security interest in and Lien on all of such Grantor’s right, title and interest in, to and under the assets set forth on Exhibit A (the “**Specified IP**”).

D. The Collateral Agent agrees to release its continuing security interest in and Lien on all of each Grantor’s right, title and interest in, to and under the Specified IP.

NOW, THEREFORE, for valuable consideration received, by its execution of this Release, the Collateral Agent hereby irrevocably and unconditionally releases, without representation, warranty or recourse, its continuing security interest in and Lien on all of each Grantor’s right, title and interest in, to and under the Specified IP.

For the avoidance of doubt, the Collateral Agent continues to maintain its continuing security interest in and Lien on all of each Grantor’s right, title and interest in, to and under all Collateral other than the Specified IP. The provisions of the Pledge and Security Agreement and the Patent Security Agreements shall, except as modified by this Release, continue in full force and effect.

This Release is governed by the law of the State of New York, excluding its choice of law principles that would result in the application of any law other than the law of the State of New York. This Release shall be binding upon, and inure to the benefit of, each Grantor and their respective successors and assigns with respect to the Specified IP (including any purchaser thereof).

*[Signature page follows]*

IN WITNESS WHEREOF, the undersigned has executed this Partial Release of Security Interest in Patents as of the date first written above.

**MUFG UNION BANK, N.A.,**  
as Collateral Agent

By: 

Name: Keith Sevigny

Title: Vice President

[Signature Page to Partial Release of Security Interest in Patents]

**PATENT**  
**REEL: 051334 FRAME: 0636**

**Exhibit A**

Specified IP

Index	Case No.	Country	Appl. No.	Filing Date	Patent No.	Issue Date
1	CD00181	US	09/855,868	5/14/2001	6,952,778	10/4/2005
2	SPN01008	US	09/973,743	10/11/2001	6,642,586	11/4/2003
3	SPN01008D1	US	10/649,994	8/28/2003	6,927,133	8/9/2005
4	SPN01008TW	TW	90123619	9/25/2001	497228	8/1/2002
5	SPN01008KR	KR	10-2002-0006849	2/6/2002	100864860	10/16/2008
6	SPN01008JP	JP	2001-031320	2/7/2001	3930256	3/16/2007
7	SPN01008EP	EP	1402621.5	10/10/2001		
8	SPN01006	US	09/795,849	2/28/2001	6,344,994	2/5/2002
9	SPN01006P1	US	60/265,426	1/31/2001		
10	SPN02006	US	10/050,483	1/16/2002	6,567,303	5/20/2003
11	SPN02006TW	TW	92100296	01/08/2003	I260639	8/21/2006
12	SPN02006WO	PCT	PCT/US2002/040775	12/17/2002		
13	SPN02006CN	CN	02827250.1	12/17/2002	ZL02827250.1	11/12/2008
14	SPN02006KR	KR	10-2004-7011031	12/17/2002		
15	SPN02006JP	JP	2003-562936	12/17/2002		
16	SPN02006GB	UK	GB0417770.5	12/17/2002	GB2400709	11/29/2005
17	SPN02006DE	DE	10297641.4	12/17/2002		
18	SPN02002	US	10/050,257	1/16/2002	6,529,412	3/4/2003
19	SPN02002WO	PCT	PCT/US2002/040823	12/17/2002		
20	SPN02002GB	UK	GB0415355A	12/17/2002	GB2400708B	8/17/2005
21	SPN02002DE	DE	10297640.6	12/17/2002		
22	SPN02002CN	CN	02827260.9	12/17/2002		
23	SPN02002KR	KR	7010943/2004	12/17/2002		
24	SPN02002JP	JP	2003-562937	12/17/2002		
25	SPN02002AU	AU	AU2002367515A1	12/17/2002		
26	SPN02002TW	TW	92100297	1/8/2003	I286753	9/11/2007
27	SPN02078	US	10/136,033	4/29/2002	6,621,742	9/16/2003
28	SPN02078JP	JP	2003-114392	4/17/2003		
29	SPN02078JPD1	JP	2007-109895	4/17/2003		
30	SPN02078JPD2	JP	2010-213935	4/17/2003	5285674	6/6/2013
31	SPN02078JPD3	JP	2010-213936	4/17/2003		
32	SPN03023	US	10/357,879	2/4/2003	6,735,114	5/11/2004
33	SPN01137	US	10/259,761	9/30/2002	6,768,682	7/27/2004
34	SPN01137JP	JP	2001-372351	12/6/2001	3987715	7/20/2007
35	SPN05128	US	11/444,216	5/30/2006	7,943,982	5/17/2011
36	SPN05128WO	PCT	PCT/JP2005/009878	5/30/2005		
37	SPN05128D1	US	13/081,777	4/7/2011	8,278,171	10/2/2012
38	SPN05128JP	JP	2007-518815	5/29/2005	5053084	8/2/2012
39	SPN05010	US	11/034,642	1/13/2005	7,130,210	10/31/2006

Index	Case No.	Country	Appl. No.	Filing Date	Patent No.	Issue Date
40	SPN05010WO	PCT	PCT/US2005/046653	12/20/2005		
41	SPN05010TW	TW	095100025	1/2/2006		
42	SPN05010KR	KR	10-2007-7016168	12/20/2005	100917690	9/9/2009
43	SPN05010JP	JP	2007-551277	12/20/2005	4674239	1/28/2011
44	SPN05010GB	UK	0714117.9	12/20/2005	2436055	7/13/2010
45	SPN05010EP	EP	5855246			
46	SPN05010DE	DE	11 2005 003 380.5	12/20/2005		
47	SPN05010CN	CN	200580046493.1	12/20/2005	ZL200580046493.1	9/14/2011
48	SPN05164CIP1	US	11/493,468	7/25/2006	7,915,663	3/29/2011
49	SPN05164CIP1D1	US	13/026,075	2/11/2011	8,369,161	2/5/2013
50	SPN05164WO-1	PCT	PCT/JP2006/314586	7/24/2006		
51	SPN05164WO	PCT	PCT/JP2005/013608	7/25/2005		
52	SPN05164JP-1	JP	2007-528452	7/24/2006		
53	SPN05164JP	JP	2007-526761	7/25/2005		
54	SPN05222	US	11/229,530	9/20/2005	7,196,938	3/27/2007
55	SPN07121	US	12/195,324	8/20/2008	8,003,468	8/23/2011
56	SPN07121D1	US	13/156,122	6/8/2011	8,318,566	11/27/2012
57	SPN15037JP	JP	2015-153353	8/20/2007		
58	SPN07121JPD1	JP	2013-257563	8/20/2007	5789654	8/7/2015
59	SPN07121JP	JP	2007-214097	8/20/2007		